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## Research Letter

# Small-scale high-cycle fatigue testing by dynamic microcantilever bending

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## **Abstract**

The lifetime of cyclically loaded devices is often limited by the fatigue resistance of their individual phases. An advanced method is presented for measuring the high-cycle fatigue behavior of materials at the micrometer scale using a nanoindenter. It is based on the cyclic deflection of focused ion beam-fabricated microcantilevers using the continuous stiffness method (CSM). In line with experimental data on bulk nanocrystalline copper, the specimens exhibit grain coarsening followed by the formation of extrusions and a fatigue strength exponent of -0.10. The method is suitable for characterizing single phases and individual components of further complex systems.

## Introduction

Many modern alloys consist of at least two different phases, such as ferrite and cementite in steel, or a layered architecture, such as in TiAl. Their combination in an ordered microstructure results in outstanding mechanical properties. While the mechanical characterization of the system can be easily done at the macroscale, the contribution of the individual phases is hard to determine. For this purpose, microscale setups were developed to measure their tensile, [1] compressive, [2] or fracture behavior. However, there are only limited possibilities to characterize the fatigue behavior at the small scale. [5–7]

Reliable cyclic methods are available for thin film testing<sup>[8–10]</sup> or for custom MEMS (micro-electro-mechanical systems), [11] but the knowledge obtained from these specific objects cannot be extrapolated to any 3D structure. Small-scale mechanical testing on other objects typically relies on nanoindentation approaches. Classical pyramidal geometries are poorly suited for accessing the local cyclic behavior<sup>[12]</sup> due to the complex stress state introduced in the sample. Methods with defined stress states should be preferred, such as micropillar compression tests<sup>[13,14]</sup> and microcantilever bending.[15,16] However, there are only few implementations reported and most of the time they are limited to low-cycle fatigue (LCF) testing. [17-19] Merle et al., [20] as well as Lavenstein et al., [21] pioneered a new approach to extend small-scale testing to the high-cycle fatigue (HCF) range based on the use of the continuous stiffness measurement (CSM) method. [22] The CSM is widely used in nanoindentation systems for monitoring the variation of the hardness and Young's modulus during indentation.<sup>[23]</sup> Independently from each other, Merle and Höppel<sup>[20]</sup> and Lavenstein et al. [21] pioneered its use as a fast actuation technique for cyclically loading focused ion beam (FIB)-structured samples. Mohanty et al.<sup>[24]</sup> further extended the testing range by introducing a piezo-based actuator.

# **Experimental**

Ultrafine-grained copper was chosen for the experiments, as its mean grain size of 157 nm is less than a tenth the size of the intended microcantilevers; hence, sampling effects are suppressed. The sample was produced by severe plastic deformation of pure copper (99.99 at.-%) in eight cycles of equal channel angular pressing (ECAP) using the B<sub>c</sub> route. The production was done by the group of Prof. Wagner at TU Chemnitz (Chemnitz, Germany). The sample was subsequently ground and electropolished. Microcantilevers were cut out using a Helios Nanolab 600i from FEI (Hilsboro, OR, USA). Gallium currents between 21 nA and 790 pA were used to fabricate cantilevers with an aspect ratio of 25:5:5 µm (L:W:T), similar to. [25]

The microcantilevers were deflected in a G200 Nanoindenter (KLA, Milpitas, CA, USA) with a 20  $\mu$ m long wedge indenter (Synton MDP, Nidau, Switzerland). The cyclic micropillar method of Merle and Höppel<sup>[20]</sup> was adapted to the testing of bending beams in fatigue. The engineering stress  $\sigma$  and strain  $\epsilon$  at the surface of the beam (see Fig. 1) are thereby calculated from the load P and displacement h recorded during the test using the classical elastic bending theory. [3] In a second step, the fatigue-specific parameters stress range  $\Delta\sigma_{\rm max}$  and strain range  $\Delta\epsilon$  at the surface of the beam are calculated from the cyclic load  $\Delta P$  and cyclic displacement  $\Delta h$ :

$$\Delta \sigma_{\text{max}} = \frac{6PL}{T W^2} \tag{1}$$

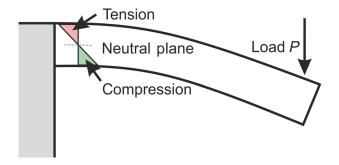


Figure 1. Schematics of the stress distribution inside a microcantilever under bending.

$$\Delta \varepsilon = \frac{3 W \Delta h}{2 L^2} \tag{2}$$

where T is the thickness, W is the width, and L is the span length between the contact point of the indenter and the root of the cantilever. Strictly speaking, the strain formula is only correct for elastic bending. It holds true as an approximation as long as only little plasticity has been accumulated.

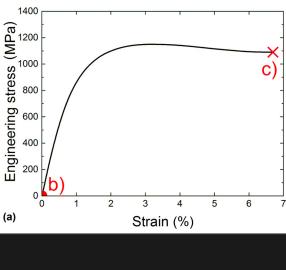
The test method consists of four steps: (i) tip approach to the surface, during which the spring constant calibration of the instrument is refined. (ii) Pre-loading of the cantilever to a stress of  $\sigma_{pre}$ , which is subsequently held constant throughout the test. This pre-compression is necessary to avoid a loss of contact between the tip and the beam during the oscillations. (iii) Ramp-up of the 40 Hz CSM oscillation up to a constant harmonic load  $\Delta P$ , which is calculated from the user-defined  $\Delta \sigma$ . (iv) Cyclic testing until failure of the samples, or interruption after 3 ×10<sup>6</sup> cycles, whichever occurs first. Failure is defined as a 20% decrease of the contact stiffness compared to its initial value. To correct displacement and stiffness effects by the penetration of the indenter into the surface, reference calibrations were made as shown in the Supplementary Material.

The top surface of the cantilevers remains in pure tension during cyclic testing, while a stress gradient reaching from tension to compression develops throughout their thickness, see Fig. 1. The extension of the plastic zone is limited to dimensions even smaller than the diameter of the cantilevers due to the presence of a neutral plane.

The presented investigations are based on approximately 30 cyclic cantilever tests. The observed behavior can be divided between three categories corresponding to low, medium, and high stress amplitudes. For comparison purposes, three cantilevers were chosen, which failed after approximately  $1.8 \times 10^6$ ,  $5.8 \times 10^5$ , and  $1.6 \times 10^5$  cycles.

# **Results and discussion** Monotonic testing

The quasi-static deformation behavior of the cantilevers was investigated prior to cyclic testing. Figure 2 shows the





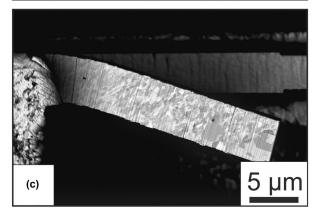


Figure 2. Monotonic microbeam bending: (a) stress-strain curve. (b,c) Electron micrographs of the specimen prior to and post testing.

engineering stress versus the engineering strain, which is calculated by Eq. (2). The yield strength is approximatively 850 MPa, and the cantilever can accumulate more than 6% deformation before failing. The low strain-hardening trend is consistent with the literature on ECAP copper. [26,27] The postmortem micrographs [Fig. 2(c)] show that the deformation is localized at the root of the cantilever, as the highest stresses are present there [see Eq. (1)]. However, the microstructure remains largely unaltered, without either grain growth or the formation of shear bands.



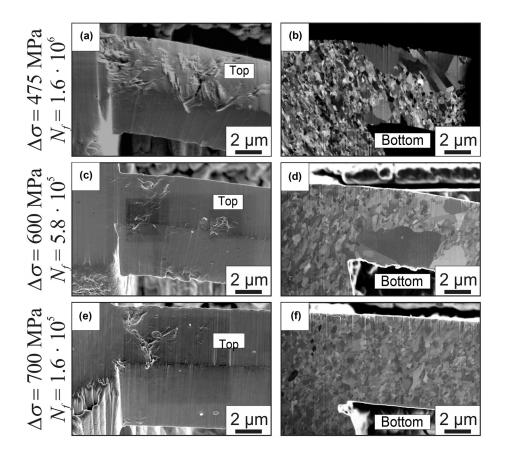


Figure 3. Electron micrographs of three representative microcantilevers after testing with different stress ranges  $\Delta \sigma$  in (a, c, e) inclined view and (b, d, f) cross-section.

## Morphology after cyclic testing

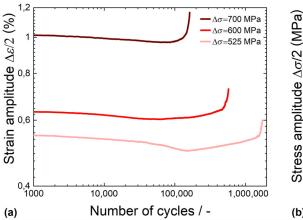
The fatigue specimens were imaged prior to cyclic testing and after the end of the test, i.e. when their stiffness had decreased by 20%. Postmortem images corresponding to three different deformation behaviors are shown in Fig. 3. The cantilever tested with the lowest stress range [Fig. 3(a)] reveals large areas of grain coarsening at the top and the bottom of the microantilever. The cantilever tested at medium stress range [Figs. 3 (c) and 3(d)] shows less grain coarsening in the cross-section and extrusions on both the upper and lower sides of the cantilever. The cantilever tested at the highest stress range is characterized by deep extrusions on its surface and very little grain coarsening in the cross-section, see [Figs. 3(e) and 3(f)]. It can be seen that the extrusions on the upper, tensile side of the cantilever coalesced and started to form a micro-crack. This corresponds to the first stage in crack growth, which would ultimately lead to the initiation of a full crack. In contrast, it seems that at lower stress amplitudes, the stresses acting upon dislocations are not sufficient for their transmission through grain boundaries, so grain coarsening needs to take place before persistent slip bands and extrusions can be formed. Such extrusions are seen when the mean grain size reaches a threshold. [28,29] Grain coarsening is therefore the limiting

stage that dominates the lifetime of the samples at medium and low stress amplitude.

Note that for most tested stress amplitudes, grain coarsening and extrusion formation are observed on both top and bottom surfaces of the cantilever. This is because their formation depends on the availability of mobile dislocations, which can be found in either of these highly stressed regions. The presence of extrusions leads to the formation of micro-cracks only at the upper surface, though, because the compressive stress found at the bottom opposes crack opening. [30,31]

#### **Evolution of cyclic parameters**

The cyclic parameters, calculated using Eqs. (1) and (2), were monitored throughout the tests and provide useful information on the fatigue mechanisms. The cyclic stress data confirmed the accuracy of the stress control by the nanoindenter: after the initial ramp-up, the stress range  $\Delta\sigma$  remained constant throughout the tests. For each test, the evolution of the strain range data  $\Delta\varepsilon$  hints at three successive stages, see [Fig. 4(a)]. At the beginning of testing,  $\Delta\varepsilon$  decreases smoothly due to cyclic hardening. This region is followed by a second stage after a minimum in strain range. There, the cyclic hardening behavior of the material is changed into cyclic softening — as visible from the smooth



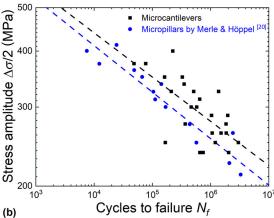


Figure 4. (a) Evolution of the strain amplitude  $\Delta\epsilon/2$  for microcantilevers tested at different stress amplitudes, corresponding to R ratios of 0.029–0.061. (b) S–N curves. The failure criterion was defined as a strain range increase of 20%. The results are compared to previous micropillar compression-compression fatigue tests on the same material.[20]

increase of  $\Delta \epsilon$ . In the last stage, the strain range increases faster due to accelerated failure. Keeping the logarithmic scale in mind, the cyclic softening stage clearly dominates the lifetime of the cantilevers. These three successive stages are observed for all tested stress ranges  $\Delta \sigma$ , their main difference being the offset between the  $\Delta \epsilon$  curves.

S-N curves were obtained by considering the previously introduced failure criterion (20% increase of  $\Delta \epsilon$ ). In [Fig. 4 (b)], the new results are compared to a previous investigation on the same material by Merle and Höppel<sup>[20]</sup> using cyclic micropillar compression. The slopes of both curves yield a similar fatigue strength exponent of approximately -0.1. However, the microcantilever data show higher scatter and longer fatigue lives. The latter can be accounted for by different R ratios during testing as well as different definitions of the failure criterion. The reasons for the higher scatter will be discussed later.

## Microstructural evolution

The cyclic hardening observed at the beginning of the tests [Fig. 4(a)] corresponds to dislocation multiplication. [32] The subsequent cyclic softening stage corresponds to microstructural coarsening of the top and bottom regions of the cantilever. On the postmortem cross-sections shown in Fig. 3, it can be seen that some grains grew in size by an order of magnitude. This is consistent with previous observations on ultrafine-grained materials. [28,33,34] Once a saturation size is reached, dislocations are free to glide on such large distances that strain coarsening is replaced by the formation of slip bands and surface extrusions.

In the last stage of cyclic testing, the extrusions grow to small cracks, which lead to a strong reduction in the beam cross-section. However, the transition from the extrusion formation to a failure by pure crack growth in crack mode I was not observed, as the experiments were stopped before this happened, due to the failure criterion on stiffness being reached. The cyclic behavior and the grain coarsening mechanism observed in this study are consistent with previous fatigue tests on high-purity ECAP copper, either on the macroscale[35,36] or on the microscale by cyclic pillar compression, [20] freestanding thin films, [8] or nanoindentation on bulk samples.[37]

# Reliability of the dynamic microcantilever

The evidenced cyclic behavior is consistent with literature data on high-purity ECAP copper. However, unlike in bulk data, the microcantilever experiments were performed at positive R ratios, which brings along cyclic creep effects. [38] This, in theory, should shorten the lifetime of the samples, as the fatigue damage is increased by creep. However, our microscale tests should hardly be affected because they only capture the early stages of crack formation. Besides, the fatigue life of highpurity metals - such as investigated for the present study is known to be dominated by the crack initiation stage. [31] Therefore, the failure criterion based on a stiffness drop by 20% seems to be a reasonable failure criterion at least for highpurity metals.

In comparison to cyclic micropillar testing, [20] the cantilever experiments exhibit a larger scattering in S-N data. This is a consequence of the testing geometry. Only a limited volume close to the surface is subjected to the highest tensile stresses during bending, see Fig. 1. Therefore, the measured cyclic behavior depends on a small number of grains and their respective orientations. The cyclic micropillar tests are more reproducible because of the larger sampled volume.

Microbeams under bending are also characterized by a large stress gradient, which leads to the piling-up of an unusually large density of dislocations at the neutral axis. The back stress of the pile-up slows down the crack propagation. [11,19] This contributes to increasing the lifetime of microbeam samples



compared to micropillars. However, this effect is convoluted and worth further investigations, as the magnitude of the stress gradient depends upon the size of the sample.

The main advantages of the microcantilevers over the micropillars are the tensile loading as well as the more natural and realistic failure criterion. The purely compressive loading of the micropillars is detrimental to comparisons with macroscopic experiments, as it does not allow for the formation of cracks and crack growth, which is typically responsible for fatigue failure. In contrast, such damage mechanisms were clearly observable in the microcantilever experiments. In the micropillar compression method, the failure criterion rather quantifies the accumulation of damage in the sample. It is only because the fatigue life of the investigated material is dominated by its microstructural evolution that the S-N curves from cyclic micropillar and microbending agree so well, as discussed above. If the lifetime would mainly depend on the crack growth rate, the microcantilever method would be preferable for lifetime predicitions, as it better covers this stage of fatigue.

In comparison to the investigations of Lavenstein et al., [21] our method can be applied ex situ. This eases the experiment in two ways: it is faster, as no glue must be hardened by an electron beam and the tip can be reused immediately, without removing the fixed cantilever from it. Also, it is not limited to the vacuum conditions of an electron microscope and hence allows the fatigue characterization under different atmospheres, closer to possible application conditions.

#### **Conclusions**

The results show that the high cycle fatigue testing of FIB-milled structures can be extended, from pure compression to bending experiments, using the continuous stiffness method (CSM). A new failure criterion was defined based on the increase of the strain range during the experiment. This criterion allows the measurement of S–N diagrams for comparing the fatigue properties of different samples.

The cantilever testing geometry was used to investigate ultrafine-grained ECAP copper samples. During testing, the cantilevers exhibited early localization of the deformation at their root. Further stages consisted of cyclic softening, grain coarsening, as well as the formation of extrusions. The observed damages are consistent with previously reported macroscopic and microscale fatigue behavior of ECAP Cu.

Following the present validation of the method, it could be used in the future to characterize the fatigue behavior of microstructural constituents, such as individual phases and grain boundaries.

# **Supplementary material**

The supplementary material for this article can be found at https://doi.org/10.1557/mrc.2020.31

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#### **References**

- D. Kiener, W. Grosinger, G. Dehm, and R. Pippan: A further step towards an understanding of size-dependent crystal plasticity: in situ tension experiments of miniaturized single-crystal copper samples. *Acta Mater.* 56, 580–592 (2008). doi:10.1016/j.actamat.2007.10.015.
- M.D. Uchic and D.M. Dimiduk: A methodology to investigate size scale effects in crystalline plasticity using uniaxial compression testing. *Mater. Sci. Eng. A* 400-401, 268–278 (2005). doi:10.1016/j.msea.2005.03.082.
- K. Matoy, H. Schönherr, T. Detzel, T. Schöberl, R. Pippan, C. Motz, and G. Dehm: A comparative micro-cantilever study of the mechanical behavior of silicon based passivation films. *Thin Solid Films* 518, 247–256 (2009). doi:10.1016/j.tsf.2009.07.143.
- T.P. Halford, D. Rudinal, K. Takashima, and Y. Higo: The effect of sample preparation upon the fracture toughness of Microsized TiAl. Key Eng. Mater. (2005). https://www.scientific.net/KEM.297-300.2416.
- S. Lavenstein and J.A. El-Awady: Micro-scale fatigue mechanisms in metals: insights gained from small-scale experiments and discrete dislocation dynamics simulations. *Curr. Opin. Solid State Mater. Sci.* 23, 100765 (2019). doi:10.1016/j.cossms.2019.07.004.
- A. Barrios, S. Gupta, G.M. Castelluccio, and O.N. Pierron: Quantitative in situ SEM high cycle fatigue: the critical role of oxygen on nanoscale-voidcontrolled nucleation and propagation of small cracks in Ni microbeams. Nano Lett. 18, 2595–2602 (2018). doi:10.1021/acs.nanolett.8b00343.
- D.H. Alsem, O.N. Pierron, E.A. Stach, C.L. Muhlstein, and R.O. Ritchie: Mechanisms for fatigue of micron-scale silicon structural films. *Adv. Eng. Mater.* 9, 15–30 (2007). doi:10.1002/adem.200600269.
- B. Merle and M. Göken: Bulge fatigue testing of freestanding and supported gold films. J. Mater. Res. 29, 267–276 (2014). doi:10.1557/jmr.2013.373.
- E. Hosseinian and O.N. Pierron: Quantitative in situ TEM tensile fatigue testing on nanocrystalline metallic ultrathin films. *Nanoscale* 5, 12532– 12541 (2013). doi:10.1039/C3NR04035 F.
- B. Putz, B. Völker, C. Semprimoschnig, and M.J. Cordill: Influence of extreme thermal cycling on metal-polymer interfaces. *Microelectron. Eng.* 167, 17–22 (2017). doi:10.1016/j.mee.2016.10.012.
- 11. F. Sadeghi-Tohidi and O.N. Pierron: Extreme stress gradient effects on microstructural fatigue crack propagation rates in Ni microbeams. *Appl. Phys. Lett.* **106**, 201904 (2015). doi:10.1063/1.4921476.
- X. Li and B. Bhushan: Development of a nanoscale fatigue measurement technique and its application to ultrathin amorphous carbon coatings. Scr. Mater. 47, 473–479 (2002). doi:10.1016/S1359-6462(02)00181-1.
- M. Schamel, J.M. Wheeler, C. Niederberger, J. Michler, A. Sologubenko, and R. Spolenak: Cyclic loading for the characterisation of strain hardening during in situ microcompression experiments. *Philos. Mag.* 96, 3479–3501 (2016). doi:10.1080/14786435.2016.1235290.
- 14. J. Schwiedrzik, R. Raghavan, A. Bürki, V. LeNader, U. Wolfram, J. Michler, and P. Zysset: *In situ* micropillar compression reveals superior strength and ductility but an absence of damage in lamellar bone. *Nat. Mater.* 13, 740–747 (2014). doi:10.1038/nmat3959.
- S. Massl, W. Thomma, J. Keckes, and R. Pippan: Investigation of fracture properties of magnetron-sputtered TiN films by means of a FIB-based cantilever bending technique. *Acta Mater.* 57, 1768–1776 (2009). doi:10.1016/j.actamat.2008.12.018.
- F. Iqbal, J. Ast, M. Göken, and K. Durst: In situ micro-cantilever tests to study fracture properties of NiAl single crystals. *Acta Mater.* 60, 1193– 1200 (2012). doi:10.1016/j.actamat.2011.10.060.

- 17. A. Wimmer, W. Heinz, T. Detzel, W. Robl, M. Nellessen, C. Kirchlechner, and G. Dehm: Cyclic bending experiments on free-standing Cu micron lines observed by electron backscatter diffraction. Acta Mater. 83, 460-469 (2015). doi:10.1016/j.actamat.2014.10.012.
- 18. M.W. Kapp, T. Kremmer, C. Motz, B. Yang, and R. Pippan: Structural instabilities during cyclic loading of ultrafine-grained copper studied with micro bending experiments. Acta Mater. 125, 351-358 (2017). doi:10.1016/j.actamat.2016.11.040.
- 19. L. Eisenhut, F. Schaefer, P. Gruenewald, L. Weiter, M. Marx, and C. Motz: Effect of a dislocation pile-up at the neutral axis on trans-crystalline crack growth for micro-bending fatigue. Int. J. Fatigue 94, 131-139 (2017). doi:10.1016/j.ijfatigue.2016.09.015.
- 20. B. Merle and H.W. Höppel: Microscale high-cycle fatigue testing by dynamic micropillar compression using continuous stiffness measurement. Exp. Mech. 58, 465-474 (2018). doi:10.1007/s11340-017-0362-3.
- 21. S. Lavenstein, B. Crawford, G.-D. Sim, P.A. Shade, C. Woodward, and J.A. El-Awady: High frequency in situ fatique response of Ni-base superalloy René-N5 microcrystals. Acta Mater. 144, 154–163 (2018). doi:10.1016/ j.actamat.2017.10.049.
- 22. B. Merle, V. Maier-Kiener, and G.M. Pharr: Influence of modulus-to-hardness ratio and harmonic parameters on continuous stiffness measurement during nanoindentation. Acta Mater. 134, 167–176 (2017). doi:10.1016/j.actamat.2017.05.036.
- 23. W.C. Oliver and J.B. Pethica: Method for Continuous Determination of the Elastic Stiffness of Contact Between Two Bodies, US4848141A, 1989.
- 24 G. Mohanty, J. Schwiedrzik, M. Polyakov, L. Petho, J.-M. Breguet, and J. Michler: Microcompression high cycle fatigue tests up to 10 million cycles. Oral Communications at: Nanomechanical Test. Mater. Res. Dev. VI. Dubrovnik, HRV, 2017.
- 25. J. Ast, T. Przybilla, V. Maier, K. Durst, and M. Göken: Microcantilever bending experiments in NiAl - evaluation, size effects, and crack tip plasticity. J. Mater. Res. 29, 2129-2140 (2014). doi:10.1557/jmr.2014.240.
- 26. E.G. Herbert, W.C. Oliver, and G.M. Pharr: Nanoindentation and the dynamic characterization of viscoelastic solids. J. Phys. Appl. Phys. 41, 074021 (2008). doi:10.1088/0022-3727/41/7/074021.
- 27. C.A. Volkert and E.T. Lilleodden: Size effects in the deformation of submicron Au columns. Philos. Mag. 86, 5567-5579 (2006). doi:10.1080/ 14786430600567739.
- 28. O. Kraft, R. Schwaiger, and P. Wellner: Fatigue in thin films: lifetime and damage formation. Mater. Sci. Eng. A 319-321, 919-923 (2001). doi:10.1016/S0921-5093(01)00990-X.
- 29. M.J. Cordill, O. Glushko, A. Kleinbichler, B. Putz, D.M. Többens, and C. Kirchlechner: Microstructural influence on the cyclic electro-mechanical behaviour of ductile films on polymer substrates. Thin Solid Films 644, 166-172 (2017). doi:10.1016/j.tsf.2017.06.067.
- 30. A.H. Cottrell, D. Hull, and N.F. Mott: Extrusion and intrusion by cyclic slip in copper. Proc. R. Soc. Lond. Ser. Math. Phys. Sci. 242, 211-213 (1957). doi:10.1098/rspa.1957.0170.
- 31. P. Paris: Proceedings Tenth Sagamore Army Materials Research Conference (Syracuse University Press, Syracuse, NY, USA 1964), pp. 107-127.
- 32. A. Vinogradov, Y. Kaneko, K. Kitagawa, S. Hashimoto, V. Stolyarov, and R. Valiev: Cyclic response of ultrafine-grained copper at constant plastic strain amplitude. Scr. Mater. 36, 1345-1351 (1997). doi:10.1016/ \$1359-6462(97)00023-7.
- 33. O. Glushko and G. Dehm: Initiation and stagnation of room temperature grain coarsening in cyclically strained gold films. Acta Mater. 169, 99-108 (2019). doi:10.1016/j.actamat.2019.03.004.
- 34. G.-D. Sim, Y.-S. Lee, S.-B. Lee, and J.J. Vlassak: Effects of stretching and cycling on the fatigue behavior of polymer-supported Ag thin films. Mater. Sci. Eng. A 575, 86-93 (2013). doi:10.1016/j.msea.2013.03.043.
- 35. H.W. Höppel, M. Kautz, C. Xu, M. Murashkin, T.G. Langdon, R.Z. Valiev, and H. Mughrabi: An overview: fatigue behaviour of ultrafine-grained metals and alloys. Int. J. Fatigue 28, 1001-1010 (2006). doi:10.1016/j. ijfatigue.2005.08.014.
- 36. H. Mughrabi, H.W. Höppel, and M. Kautz: Fatigue and microstructure of ultrafine-grained metals produced by severe plastic deformation. Scr. Mater. 51, 807-812 (2004). doi:10.1016/j.scriptamat.2004.05.012.

- 37. M.J. Cordill, M.S. Lund, J. Parker, C. Leighton, A.K. Nair, D. Farkas, N.R. Moody, and W.W. Gerberich: The Nano-Jackhammer effect in probing near-surface mechanical properties. Int. J. Plast. 25, 2045-2058 (2009). doi:10.1016/j.ijplas.2008.12.015.
- 38. R. Eckert, C. Laird, and J. Bassani: Mechanism of fracture produced by fatigue cycling with a positive mean stress in copper. Mater. Sci. Eng. 91, 81-88 (1987). doi:10.1016/0025-5416(87)90285-0.